Yimin Wang

Tel: +65-87726536 | Email: yimin.wang@u.nus.edu

Education

National University of Singapore (NUS), Singapore Ph.D. student, Electrical and Computer Engineering	2022—Present GPA: 4.83/5.0
Fudan University (FDU), Shanghai, China	2019—2021
Ph.D. student, Microelectronics and Solid-state Electronics	GPA: 3.72/4.0
Jilin University (JLU), Changchun, China	2015—2019
B.Sc., Electronic Information Science and Technology	GPA: 3.92/4.0

Research Interest

Circuits and systems; processing-in-memory architecture; hardware-software co-design for AI accelerator

Publications

In preparation

- [J4] Y. Wang, YJ. Chong, Z. Wu, and X. Fong, "LLM Inference Acceleration on Scalable PIM Architecture with Balanced Dataflow and Fine-Grained Parallelism". (Extended from ICCAD25)
- [J3] Y. Wang and X. Fong, "Ising Machine with Asynchronous Latches and Boolean Logics for Versatile COP Solving". (Extended from ISCAS24)

Under review

• [J2] Y. Wang, Z. Wu, YJ. Chong, and X. Fong, "JADE: Joint Architecture-Dataflow Exploration for LLM Inference on Heterogeneous In- and Near-memory Computing Systems".

• IBC11 Y. Wang and X. Fong, "Machine Learning Acceleration in Embedded Non-volatile Memory Subsystems for Edge

• [BC1] Y. Wang and X. Fong, "Machine Learning Acceleration in Embedded Non-volation Computing," Non-Volatile Memory and Selector Devices: Technology and Applications, Wile				
 [C4] Y. Wang, YJ. Chong, and X. Fong, "LEAP: LLM Inference on Scalable PIM-NoC Architecture with Balanced Dataflow and Fine-Grained Parallelism," <i>IEEE/ACM International Conference on Computer-Aided Design (ICCAD)</i>, 2025. Published [C3] Y. Wang and X. Fong, "Energy-Efficient Ising Machines Using Capacitance-Coupled Latches for MaxCut Solving," <i>IEEE International Symposium on Circuits and Systems (ISCAS)</i>, 2024. [C2] Y. Wang, Y. Cen, and X. Fong, "Design Framework for Ising Machines with Bistable Latch-Based Spins and All-to-All Resistive Coupling," <i>IEEE International Symposium on Circuits and Systems (ISCAS)</i>, 2024. [J1] Y. Wang and X. Fong, "Benchmarking DNN Mapping Methods for the In-Memory Computing Accelerators," <i>IEEE Journal on Emerging and Selected Topics in Circuits and Systems (JETCAS)</i>, 2023. [C1] Y. Wang, Z. Zou, and L. Zheng, "Design Framework for SRAM-Based Computing-In-Memory Edge CNN Accelerators," 				
			IEEE International Symposium on Circuits and Systems (ISCAS), 2021.	michiery Eage er it villes crattered;
			Work Experience	
			Research intern, Advanced Micro Devices (AMD), Singapore	May 2024—November 2024
			Awards	
			Third prize, 1st IEEE SEACAS Chipathon organized by IEEE CAS Society	Academic Year 2023-2024
			Micron Foundation Prize, National University of Singapore	Academic Year 2021-2022
			First-Class Scholarship, Fudan University	Academic Year 2019-2020
			Outstanding Graduate, Jilin University	Academic Year 2018-2019
Samsung Scholarship, Jilin University	Academic Year 2017-2018			
First-Class Scholarship, Jilin University Academic Year 2015-2016, 2016-2017, 2017-2018				
Teaching				
Teaching assistant, CEG5202 Embedded Software Systems and Security, NUS	Spring 2023 and Spring 2024			
Teaching assistant, CEG5201 Hardware Technologies, Principles, & Platforms, NUS	Fall 2023			
Teaching assistant, TIE2030 Programming Methodology with Python, NUS	Fall 2022 and Fall 2023			
Teaching assistant, TEE2101 Programming Methodology, NUS	Spring 2023			
Teaching assistant, Internet of Things, FDU	Fall 2020			
Academic Service				
Committee member, IEEE Circuits and Systems Society (CASS), NUS Student Chapter	November 2023-Present			
Reviewer, IEEE Transactions on Circuits and Systems I: Regular Papers (TCAS-I)	January 2024–Present			
Reviewer, IEEE Transactions on Very Large Scale Integration (VLSI) Systems	January 2024–Present			
Reviewer, 2025 IEEE International Symposium on Circuits and Systems (ISCAS)	January 2025			
Reviewer, 2024 ACM/IEEE International Conference on Computer-Aided Design (ICCAD)	June 2024			

Committee member, IEEE Circuits and Systems Society (CASS), NUS Student Chapter	November 2023-Present
Reviewer, IEEE Transactions on Circuits and Systems I: Regular Papers (TCAS-I)	January 2024–Present
Reviewer, IEEE Transactions on Very Large Scale Integration (VLSI) Systems	January 2024–Present
Reviewer, 2025 IEEE International Symposium on Circuits and Systems (ISCAS)	January 2025
Reviewer, 2024 ACM/IEEE International Conference on Computer-Aided Design (ICCAD)	June 2024